



Product Change Notification - SYST-02LKZW876

Date:

03 May 2019

Product Category:

16-Bit - Microcontrollers and Digital Signal Controllers

Affected CPNs:



Notification subject:

ERRATA - dsPIC33CK64MP1xx Family Silicon Errata Errata Document Revision

Notification text:

SYST-02LKZW876

Microchip has released a new DeviceDoc for the dsPIC33CK64MP1xx Family Silicon Errata of devices. If you are using one of these read the document located at [dsPIC33CK64MP1xx Family Silicon Errata](#)

Notification Status: Final

Description of Change: Added silicon issue 16 (DMA).

Impacts to Data Sheet: None

Reason for Change: To Improve Productivity

Change Implementation Status: Complete

Date Document Changes Effective: 03 May 2019

NOTE: Please be advised that this is a change to the document only the product has not been changed.

Markings to Distinguish Revised from Unrevised Devices: N/A

Attachment(s):

[dsPIC33CK64MP1xx Family Silicon Errata](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

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Affected Catalog Part Numbers (CPN)

DSPIC33CK64MP105-E/M4

DSPIC33CK64MP105-E/PT

DSPIC33CK64MP105-I/M4

DSPIC33CK64MP105-I/PT

DSPIC33CK64MP105T-I/M4

DSPIC33CK64MP105T-I/PT

dsPIC33CK64MP105 Family Silicon Errata and Data Sheet Clarification

The dsPIC33CK64MP105 family devices that you have received conform functionally to the current Device Data Sheet (DS70005363C), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in [Table 1](#). The silicon issues are summarized in [Table 2](#).


The errata described in this document will be addressed in future revisions of the dsPIC33CK64MP105 silicon.

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated in the last column of [Table 2](#) apply to the current silicon revision (**A0**).

Data Sheet clarifications and corrections start on [page 6](#), following the discussion of silicon issues.

The silicon revision level can be identified using the current version of MPLAB® IDE and Microchip's programmers, debuggers, and emulation tools, which are available at the Microchip corporate website (www.microchip.com).

For example, to identify the silicon revision level using MPLAB IDE in conjunction with a hardware debugger:

1. Using the appropriate interface, connect the device to the hardware debugger.
2. Open an MPLAB IDE project.
3. Configure the MPLAB IDE project for the appropriate device and hardware debugger.
4. Based on the version of MPLAB IDE you are using, do one of the following:
 - a) For MPLAB IDE 8, select *Programmer > Reconnect*.
 - b) For MPLAB X IDE, select *Window > Dashboard* and click the **Refresh Debug Tool Status** icon ().
5. Depending on the development tool used, the part number *and* Device Revision ID value appear in the **Output** window.

Note: If you are unable to extract the silicon revision level, please contact your local Microchip sales office for assistance.

The DEVREV values for the various dsPIC33CK64MP105 silicon revisions are shown in [Table 1](#).

TABLE 1: SILICON DEVREV VALUES

Part Number	Device ID ⁽¹⁾	Revision ID for Silicon Revision
		A0
dsPIC33CK32MP102	0x8E00	0x0000
dsPIC33CK32MP103	0x8E01	
dsPIC33CK32MP105	0x8E02	
dsPIC33CK64MP102	0x8E10	
dsPIC33CK64MP103	0x8E11	
dsPIC33CK64MP105	0x8E12	

Note 1: The Device IDs (DEVID and DEVREV) are located at the last two implemented addresses of configuration memory space. They are shown in hexadecimal in the format “DEVID DEVREV”.

dsPIC33CK64MP105

TABLE 2: SILICON ISSUE SUMMARY

Module	Feature	Item Number	Issue Summary	Affected Revisions
				A0
I ² C	Interrupt	1.	In Slave mode, an incorrect interrupt is generated when DHEN = 1.	X
I ² C	Idle	2.	Module SFR registers are reset in Idle mode.	X
I ² C	SMBus 3.0	3.	When Configuration bit, SMB3EN (FDEVOP[10]) = 1, the SMBus 3.0 V _{IH} minimum specification may not be met.	X
Oscillator	XT, HS	4.	The Primary Oscillator Start-up Timer (OST) may indicate the oscillator is ready for use too early.	X
PWM	Dead Time	5.	When feed-forward PCI is used for dead-time compensation (DTCMPSEL = 1), the PWMx outputs are overridden.	X
UART	Frame Error	6.	FERR bit will not get set if a Stop bit is received.	X
UART	Sleep	7.	SLPEN needs to be set when waking from Sleep with a UART reception.	X
UART	Address Detect	8.	When writing to UxP1 with UTXBRK = 1, the content of P1 will not get transmitted.	X
UART	IrDA [®]	9.	When the UART is operating in IrDA mode, the received data may be corrupted.	X
I/O	POR	10.	Spike on I/O at POR.	X
ICSP [™] Flash Write Inhibit	Flash Write Inhibit	11.	Flash memory cannot be protected against reprogramming.	X
CPU	FLIM Instruction	12.	When the operands are of different signs, the FLIM instruction may not force the correct data limit.	X
CPU	DIV.SD Instruction	13.	Overflow bit is not getting set when an overflow occurs.	X
CPU	MAXAB/MINAB/ MINZAB Instructions	14.	MAXAB, MINAB and MINZAB do not work for different sign operands.	X
CPU	Byte Mode Instructions	15.	Upper byte of the destination register may not be persistent.	X
DMA	ADC Triggers	16.	DMA is triggered continuously from ADC.	X

Silicon Errata Issues

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the shaded column in the following tables apply to the current silicon revision (**A0**).

1. Module: I²C

In Slave mode with DHEN = 1 (Data Hold Enable), if software sends a NACK, a Slave interrupt is asserted at the 9th falling edge of the clock.

Work around

Software should ignore the Slave interrupt that is asserted after sending a NACK.

Affected Silicon Revisions

A0								
X								

2. Module: I²C

In Slave mode, the SFRs are reset when the device is in Idle and the module is set for discontinue in Idle (I2CSIDL = 1).

Work around

None.

Affected Silicon Revisions

A0								
X								

3. Module: I²C

When selecting SMBus 3.0 operation using Configuration bit, SMB3EN (FDEVOP[10]), the Voltage Input High (V_{IH}) of the SMBus 3.0 specification minimum may not be met.

Work around

None.

Affected Silicon Revisions

A0								
X								

4. Module: Oscillator

The Primary Oscillator Start-up Timer (OST) may indicate the oscillator is ready for use too early. Clocking the device before the oscillator is ready may result in incorrect execution and exceptions. This issue exists when the POSC is requested at power-on, during clock switching, when waking from Sleep or when a peripheral module requests the POSC directly. This issue affects XT and HS modes only.

Work around

Make sure that the Primary Oscillator clock is ready before using it by following these steps:

1. Running on a non-POSC source, request the POSC clock using a peripheral such as REFO.
2. Provide a delay to stabilize the POSC.
3. Then, switch to the POSC source.

Affected Silicon Revisions

A0								
X								

5. Module: PWM

When feed-forward PCI is used for dead-time compensation (DTCMPSEL = 1), the PWMx outputs are overridden.

Work around

Use Sync PCI (DTCMPSEL = 0) for dead-time compensation.

Affected Silicon Revisions

A0								
X								

6. Module: UART

When UART is operating with STSEL[1:0] = 2, (two Stop bits sent, two checked at receive) and STPMD = 0, the FERR bit will not get set if a Stop bit is received.

Work around

Use STPSEL = 3 instead of STSEL = 2. When operating with STSEL = 3 mode, the UART will be configured to send two Stop bits, but check one at receive.

Affected Silicon Revisions

A0								
X								

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7. Module: UART

When waking from Sleep with a UART reception, SLPEN needs to be set in addition to WAKE = 1.

Work around

Set the SLEN bit in addition to WAKE before entering Sleep.

Affected Silicon Revisions

A0							
X							

8. Module: UART

In UART Address Detect mode, writing to UxP1 with UTXBRK = 1 should cause a Break to be transmitted, followed by the content in P1, but the content of P1 will not get transmitted.

Work around

After writing to P1, wait for UTXBRK to get clear and then rewrite to P1.

Affected Silicon Revisions

A0							
X							

9. Module: UART

When the UART is operating in IrDA[®] mode, the received data may be corrupted.

Work around

None.

Affected Silicon Revisions

A0							
X							

10. Module: I/O

At device power-up, the I/O pins may drive a pulse up to 0.8V for a duration of up to 100 μ Sec.

Work around

It is recommended to ensure the circuitry that is connected to the pins can endure this pulse.

Example applications affected may include complementary power switches, where a transient current shoot-through might occur.

High-voltage applications with complementary switches should power the high-voltage 200 μ Sec later than powering the dsPIC[®] DSC to avoid the issue.

Behavior is specific to each part and not affected by aging.

Affected Silicon Revisions

A0							
X							

11. Module: ICSP[™] Flash Write Inhibit

The ICSP Write Inhibit feature does not prevent ICSP Flash erase and program operations, even if the lock values are written.

Work around

None.

Affected Silicon Revisions

A0							
X							

12. Module: CPU

The FLIM instruction may incorrectly limit the data range when operating on signed operands of different sign values. If the operands are either all negative or all positive, the limit is correct.

Work around

None.

Affected Silicon Revisions

A0							
X							

13. Module: CPU

When using the Signed 32-by-16-bit Division instruction, `DIV.SD`, the Overflow bit may not always get set when an overflow occurs.

Work around

Test for and handle overflow conditions outside of the `div.sd` instruction.

Affected Silicon Revisions

A0								
X								

14. Module: CPU

When operating on signed operands of different sign values, the output for `MAXAB`, `MINAB` and `MINZAB` instructions may be incorrect. If the operands are either all negative or all positive, the output is correct.

Work around

None.

Affected Silicon Revisions

A0								
X								

15. Module: CPU

When using Byte mode instructions, the upper byte of the destination register may not be persistent.

Work around

None.

Affected Silicon Revisions

A0								
X								

16. Module: DMA

The DMA receives multiple continuous triggers from ADC until the trigger event from ADC is cleared. The `OVRUNIF` flag (`DMAINTn[3]`) will be set. When the `OVRUNIF` bit changes state, from '0' to '1', a DMA interrupt is generated.

Work around

Ignore the `OVRUNIF` bit and the first DMA interrupt. Clear the ADC trigger source, `ANxRDY`, with a DMA read of the ADC buffer, `ADCBUFx`, for the corresponding ADC channel.

Affected Silicon Revisions

A0								
X								

dsPIC33CK64MP105

Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS70005363C):

<p>Note: Corrections are shown in bold. Where possible, the original bold text formatting has been removed for clarity.</p>

None.

APPENDIX A: DOCUMENT REVISION HISTORY

Rev A Document (1/2019)

Initial version of this document; issued for revision A0.

Rev B Document (2/2019)

Updated device data sheet revision from B to C.

Rev C Document (3/2019)

Added silicon issue 16 ([DMA](#)).

dsPIC33CK64MP105

NOTES:

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- Microchip products meet the specification contained in their particular Microchip Data Sheet.
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